

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"20060216495".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 12:58
L2	1	2005-152068.NRAN.	DERWENT	OR	OFF	2008/06/19 13:01
L3	0	us20060216495-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:02
L4	2	us-20060216495-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:02
L5	4	JP-2001102758-\$.did. jp-09136943-\$.did. jp-200320327-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:06
L6	6	JP-2001102758-\$.did. jp-09136943-\$.did. jp-2003020327-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:07
L7	1133142	silica (silicon adj2 (oxide dioxide)) "sio2" "sio.sub.2"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:08
L8	7070	l7 with (lamellar planar)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:08
L9	692669	epox\$6 diepox\$6 triepox\$6 polypox\$6 glycidyl\$ diglycidyl\$ triglycidyl\$ tetraglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:09
L10	48	L9 and (novolak novolac novalac novalac) and l8	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:09

L11	684346	(surface adj2 area) "ssa" "s.s.a."	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:10
L12	897248	(particle particulate grain) near5 (size diameter micron micrometer nanometer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:11
L13	14	110 and 111 and 112	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:11
L14	19518	(17 silicate) with (lamellar planar plane flake)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:15
L15	185	114.ab. and 19.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:15
L16	17	(novolak novolac novolak novolac) and 115	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:16
L17	112	(novolak novolac novolak novolac) and 114 and 111 and 112	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:19
L18	38	(novolak novolac novolak novolac) and 114 and 111 and 112 and ((wiring circuit) adj2 board)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:20
L19	30	motobe-h\$.in. motobe-h\$.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:31
L20	598	hibino-a\$.in. hibino-a\$.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:31

L21	53474	ito-k\$ in. ito-k\$-\$. in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:32
L22	9	I19 and I20 and I21	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:32
L23	897711	matsushita.as.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:33
L24	21	(I19 I20 I21 I22 I23) and I9 and I14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:34
L25	38	(novolak novolac novolak novolac) and I14 and I11 and I12 and ((wiring circuit) adj2 board)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:39
L26	372	(interplanar near3 spacing). clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:46
L27	34	I26 and I9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:47
L28	109	michigan.as. and lamellar	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:48
L29	26	pinnavaia.in. and I9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:49
L30	12	pinnavaia.in. and I9 and I7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:50

L31	13	pinnavaia.in. and I9 and I14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:51
L32	0	I31 and ((wiring circuit) adj2 board)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:54
L33	0	I31 and prepreg	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:55
L34	14458	((I7 silicate) near3 (lamellar planar plane flake layered exfoliat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:56
L35	2846	I34 and I9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:56
L36	224	I35 and ((wiring circuit) adj2 board)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:56
L37	7206	((I7) near3 (lamellar planar plane flake layered exfoliat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:56
L38	140	I36 and I37	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 13:57
L39	2	"20060216495".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:01
L40	28	((novolak novolac novalak novolac) and I38	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:12

L41	27	(cresole resolol cresol resol) and l38	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:12
L42	357156	curative hardener (cross adj2 linker) crosslinker ((curing hardening (cross adj2 linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:13
L43	20	((phenol phenolic) with L42) and l38	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:13
L44	48	l36 and l37 and (impregnat\$4 prepreg)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:14
L45	13	l37.ab. and l11.ab. and l12.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:17
L46	27004	((l7) near3 (lamellar planar plane flake layered exfoliat\$4 scaly plate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:19
L47	27	l46.ab. and l11.ab. and l12.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:20
L48	47	l46 same l11 same l12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:21
L49	11	((l46 same l11 same l12) and (electronic ((wiring circuit) adj2 board) prepreg impregnat \$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:22
L50	2915	l46.ab. l46.ti.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:31

L51	62	I50 and I11 and I12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:31
L52	12	I51 and (((wiring circuit) adj2 board) prepreg impregnat\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:39
L53	1879	(I7) near3 (crushed)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:55
L54	364	I53 and I11 and I12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:56
L55	119	I54 and (((wiring circuit) adj2 board) prepreg impregnat\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:56
L56	12	"I55" and (((wiring circuit) adj2 board) prepreg impregnat\$) and I9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:56
L57	36	I54 and (((wiring circuit) adj2 board) prepreg impregnat\$) and I9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 14:57
L58	10	I54 and (((wiring circuit) adj2 board) prepreg impregnat\$) and I9 and (novolak novolac novalak novolac)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:03
L59	10	I54 and (((wiring circuit) adj2 board) prepreg impregnat\$) and I9 and (novolak novolac novalak novolac) and (accelerator catalyst)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:03
L60	439	((I7) near3 (crushed fused)) same I11 same I12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:14

L61	70	I60 and (((wiring circuit) adj2 board) prepreg impregnat\$) and I9 and (novolak novolac novalak novolac) and (accelerator catalyst)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:15
L62	47	I60 and (((wiring circuit) adj2 board) prepreg impregnat\$) and I9 and (novolak novolac novalak novolac) and (accelerator catalyst) and (prepreg impregnat\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:16
L63	4	I60 and (prepreg impregnat\$). ab. and I9.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:18
L64	52	I60 and ((prepreg impregnat\$) same I9)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:19
L65	585	((I7) near3 (crushed fused)) and ((prepreg impregnat\$) same I9)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:20
L66	205	((((I7) near3 (crushed))) same (I11 I12)) and I11 and I12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:21
L67	5	I66 and ((prepreg impregnat\$) same I9)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:22
L68	1	wo-0151562-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:25
L69	1	2001-611031.NRAN.	DERWENT	OR	OFF	2008/06/19 15:25
L70	9621	428/297.4.ccls. 428/413.ccls. 428/414.ccls. 428/415.ccls. 428/416.ccls. 428/417.ccls. 428/418.ccls. 428/901.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:28
L71	5	I70 and I66	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 15:28

S25	496814	silicone polysiloxane polyorganosiloxane polydiorganosiloxane organopolysiloxane organosiloxane diorganopolysiloxane siloxane organosilicone	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/14 09:00
S26	317795	curative hardener (cross adj2 linker) crosslinker ((curing hardening (cross adj2 linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/28 14:33
S27	1222941	amine amino diamine diamino triamine triamino polyamine polyamino	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/12 13:13
S28	605176	epox\$6 diepox\$6 triepox\$6 polyepox\$6 glycidyl\$ diglycidyl\$ triglycidyl\$ tetraglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/14 09:01

6/19/08 3:29:46 PM

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